503698912 02/18/2016

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT3745550

SUBMISSION TYPE:				
NATURE OF CONVEYANCE:		ASSIGNMENT	ASSIGNMENT	
CONVEYING PARTY DA	ATA			
		Name	Execution Date	
NIPPON STEEL & SUMI	KIN MAT	ERIALS CO., LTD.	02/10/2016	
RECEIVING PARTY DA	ТА			
Name:	NIPPON VENTURE BUSINESS CAPITAL CO., LTD.			
Street Address:	2-5-5, SHIMODERA			
Internal Address:	NANIWA-KU, OSAKA-SHI			
City:	OSAKA			
State/Country:	JAPAN			
	•			
PROPERTY NUMBERS	Total: 1			
Property Type		Number]	
Patent Number: 6884		884708		
CORRESPONDENCE D	ΑΤΑ			
, , ,		212)425-5288		
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-		124257200		
Email: NBE		IBENOWITZ@KENYON.COM	NOWITZ@KENYON.COM	
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		ENYON & KENYON LLP		
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ATTORNEY DOCKET NUMBER:		52433/1144	52433/1144	
NAME OF SUBMITTER:		KEVIN T. GODLEWSKI	KEVIN T. GODLEWSKI	
SIGNATURE:		/KEVIN T. GODLEWSKI/	/KEVIN T. GODLEWSKI/	
DATE SIGNED:		02/18/2016	02/18/2016	
Total Attachments: 2		·		
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ASSIGNMENT

WHEREAS, NIPPON STEEL & SUMIKIN MATERIALS CO., LTD., a corporation organized under and by virtue of the laws of Japan and having a place of business at 7-16-3, Ginza, Chuo-ku, Tokyo, 104-0061, Japan, and who, together with its successors, assigns and legal representatives (hereinafter ASSIGNOR), owns right, title and interest in and to United States Patent No. 6,884,708, issued April 26, 2005, entitled METHOD OF PARTIALLY PLATING SUBSTRATE FOR ELECTRONIC DEVICES and to the inventions described and claimed therein (hereinafter SUBJECT PATENT); and

WHEREAS, NIPPON VENTURE BUSINESS CAPITAL CO., LTD., a

corporation organized under and by virtue of the laws of Japan and having a place of business at 2-5-5, Shimodera, Naniwa-ku, Osaka-shi, Osaka, Japan, and who, together with its successors, assigns and legal representatives (hereinafter ASSIGNEE), is desirous of acquiring ASSIGNOR's right, title and interest in and to the SUBJECT PATENT;

NOW, THEREFORE, for valuable consideration furnished by ASSIGNEE to ASSIGNOR, the receipt and sufficiency of which is hereby acknowledged, ASSIGNOR hereby assigns, sells and transfers unto the said ASSIGNEE, its successors and assigns, ASSIGNOR's right, title and interest in and to the SUBJECT PATENT, and all reissues, extensions, renewals and reexamination certificates thereof, to the full end of the term or terms for which SUBJECT PATENT is issued, the same to be held and enjoyed by ASSIGNEE, its successors and assigns, the same as it would have been held and enjoyed by ASSIGNOR if this Assignment had not been made; together with all claims or damages by reason of past infringement of SUBJECT PATENT; with the right to sue for, and collect the same for its own use and for the use of its successors and assigns. The undersigned represents he has authority from NIPPON STEEL & SUMIKIN

MATERIALS CO., LTD. to execute this Assignment,

IN TESTIMONY WHEREOF, NIPPON STEEL & SUMIKIN MATERIALS CO.,

LTD., has hereunto set its hand this <u> 10^{+h} </u> day of <u>February</u>, 2016.

NIPPON STEEL & SUMIKIN MATERIALS CO., LTD.

By: Konji Gamada

Typed Name: Kenji Yamada

Title: President, Representative Director

Date: Feb. 10, 2016

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RECORDED: 02/18/2016